MA27P02

Silicon epitaxial planar type

For high frequency switch

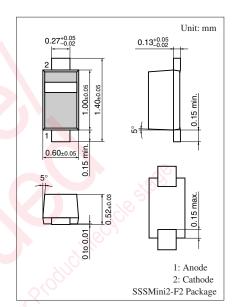
■ Features

- Small terminal capacitance C_t
- Small forward dynamic resistance r_f
- Ultraminiature package and surface mounting type 1.0 mm × 0.6 mm (height: 0.52 mm)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	60	V	
Forward current	I_{F}	100	mA	
Power dissipation *	P _D	150	mW	
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

Note) *: With a glass epoxy PC board



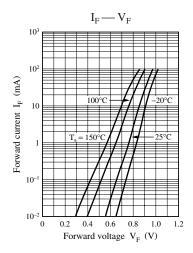
Marking Symbol: Y

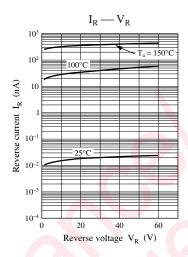
■ Electrical Characteristics T_a = 25°C ± 3°C

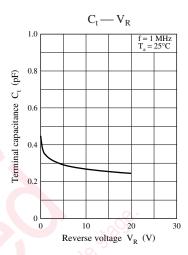
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$	2.90		1.0	V
Reverse current	I_R	$V_R = 60 \text{ V}$			100	nA
Terminal capacitance	C_{t}	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$			0.5	pF
Forward dynamic resistance *	r_{f}	$I_F = 10 \text{ mA}, f = 100 \text{ MHz}$			2.0	Ω

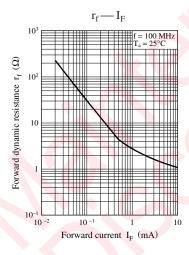
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. *: r_f measurement device ; agilent model 4291B









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